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Specification

MCT043D6W480272LSL



Version History

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1. Application

This Specification is applicable to 10.9cm (4.3 inch) Blanview TFT-LCD monitor for non-military use.

- ⑥ÁT ãaæ ÁÔ[{] [} ^ } o makes no warranty or assume no liability that use of this Product and/or any information including drawings in this Specification by Purchaser is not infringing any patent or other intellectual property rights owned by third parties, and T ãaæ ÁÔ[{] [} ^ } o shall not grant to Purchaser any right to use any patent or other intellectual property rights owned by third parties. Since this Specification contains T ãaæ ÁÔ[{] [} ^ } o confidential information and copy right, Purchaser shall use them with high degree of care to prevent any unauthorized use, disclosure, duplication, publication or dissemination of T ãaæ ÁÔ[{] [} ^ } o confidential information and copy right.
- This Product shall not be used for application which requires extremely higher level of reliability and/or safety such as aerospace equipment, telecommunication equipment for trunk lines, control equipment for nuclear facilities or life-support medical equipment.
- T aaæ Kô[{][}^} o assumes no liability for any damage resulting from misuse, abuse, and/or miss-operation of the Product deviating from the operating conditions and precautions described in the Specification.
- ⑤ If any issue arises as to information provided in this Specification or any other information, T aæ kô[{][}^) and Purchaser shall discuss them in good faith and seek solution.

This Product is compatible for RoHS directive.

Object substance	Maximum content [ppm]
Cadmium and its compound	100
Hexavalent Chromium Compound	1000
Lead & Lead compound	1000
Mercury & Mercury compound	1000
Polybrominated biphenyl series (PBB series)	1000
Polybrominated biphenyl ether series (PBDE series)	1000

2. Outline Specifications

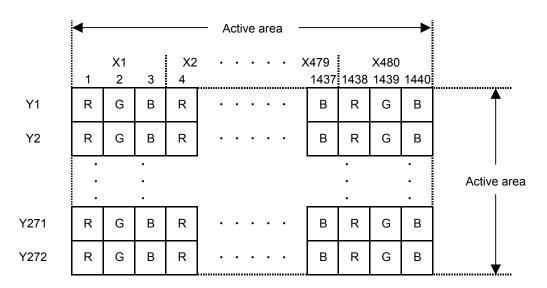
2.1 Features of the Product

- 4.3 inch diagonal display, 1,440 [H] x 272 [V] dots.
- 8-bit 16,777,216 color display capability.
- Single power supply operation of 3.3V.
- Built in Timing generator (TG), Counter-electrode driving circuitry and power supply circuit.
- High bright white LED back-light.
- Blanview TFT-LCD, improved outdoor readability.

	Ind	oor	Outo	Outdoor		
	Readability	Power Efficiency (Battery Life)	Readability	Power Efficiency (Battery Life)		
Transmissive	Good	Good	Fair	Poor		
Transflective	Fair	Poor	Good	Good		
Blanview	Good	Good	Good	Good		

2.2 Display Method

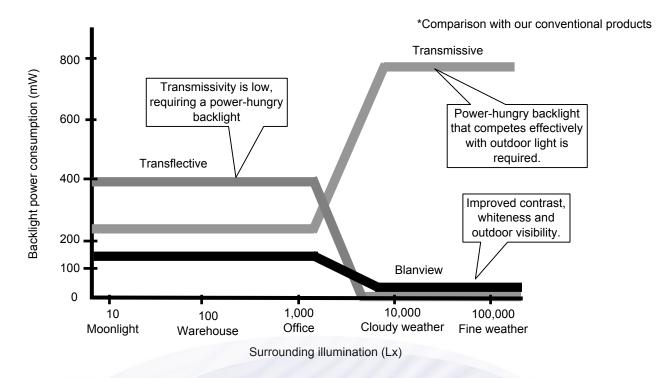
Items	Specifications	Remarks
Display t <mark>ype</mark>	TN type 16,777,216 colors.	
	Blanview, Normally white.	
Driving method	a-Si TFT Active matrix.	
	Lin <mark>e-sc</mark> anni <mark>ng,</mark> Non-interlace.	
Dot arrangement	RGB stripe arrangement.	Refer to "Dot arrangement".
Signal input method	8-bit RGB, parallel input.	11
Backlight type	High bright white LED.	



Dot arrangement (FPC cable placed downside)

<Features of Blanview>

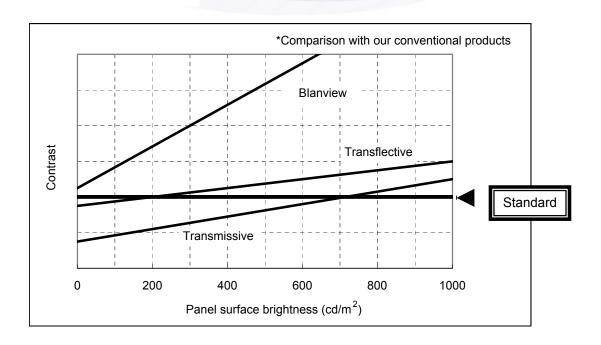
- Backlight power consumption required to assure visibility. (equivalent to 3.5"QVGA)



- Contrast characteristics under 100,000Lx. (same condition as direct sunlight.)

With better contrast (higher contrast ratio), Blanview TFT-LCD has the best outdoor readability in three different types of TFT-LCD.

Below chart shows contrast value against panel surface brightness. (Horizontal: Panel surface brightness/ Vertical: Contrast value) LCD panel has enough outdoor readability above our Standard line.

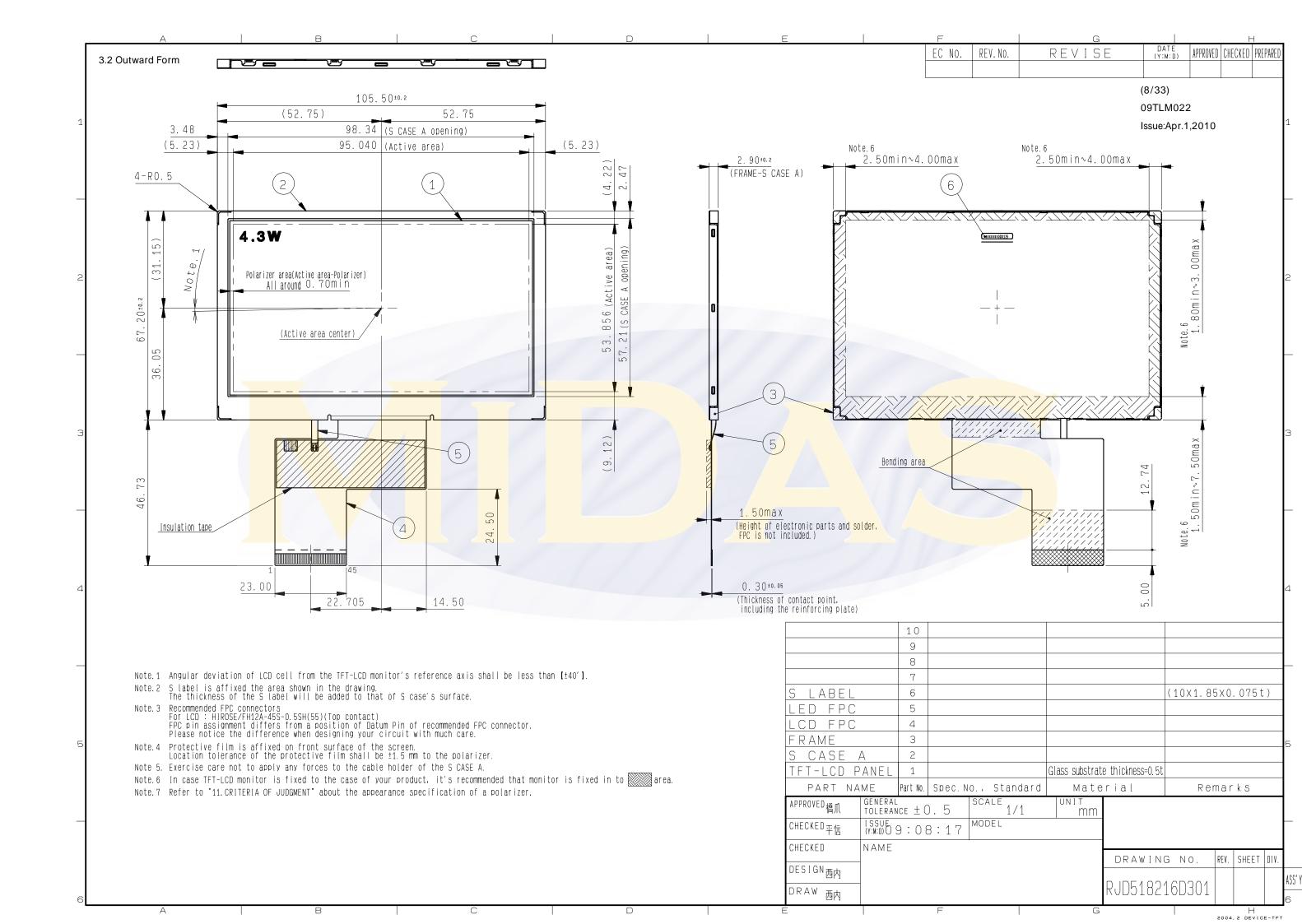


3. Dimensions and Shape

3.1 Dimensions

Items	Specifications	Unit	Remarks
Outline dimensions	105.50[H] × 67.20[V] × 2.90[D]	mm	Exclude FPC cable.
Active area	95.040[H] × 53.856[V]	mm	10.9cm diagonal.
Number of dots	1,440[H] × 272[V]	dot	
Dot pitch	66.0[H] × 198.0[V]	μm	
Surface hardness of the polarizer	3	Н	Load:2.0N
Weight	40.0	g	Include FPC cable.





3.3 Serial Label (S-LABEL)

1) Display Items

S-label indicates the least significant digit of manufacture year (1digit), manufacture month with below alphabet (1letter), model code (5characters), serial number (6digits).

* Contents of Display

*	*	****	*****
_	_		
а	b	С	d

	Contents of display								
а	The least significant	The least significant digit of manufacture year							
b	Manufacture month	nonth Jan-A May-E Sep-I							
		Feb-B	Jun-F	Oct-J					
		Mar-C	Jul-G	Nov-K					
		Apr-D	Aug-H	Dec-L					
С	Model code	43BGC (Made in Japa	n)						
		43BHC (Made in Malaysia)							
	43BJC (Made in China)								
d	Serial number								

^{*} Example of indication of Serial label (S-label)

means "manufactured in November 2009, model 43BG, C specifications, serial number 000125"

· Made in Malaysia

means "manufactured in November 2009, model 43BH, C specifications, serial number 000125"

Made in China

means "manufactured in November 2009, model 43BJ, C specifications, serial number 000125"

2) Location of Serial Label (S-label) Refer to 3.2 "Outward Form".

[·] Made in Japan

4. Pin Assignment

No.	Symbol	Function
1	VSS	GND.
2	VSS	GND.
3	VDD	
4	VDD	Power supply.
5	D00	Power supply.
6		Display data(D)
	D01	Display data(R).
7	D02	00h: Black
8	D03	D00:LSB D07:MSB
9	D04	Driver has internal account and an arrival
10	D05	Driver has internal gamma conversion.
11	D06	
12	D07	
13	D10	D: 15 15(1)(0)
14	D11	Display data(G).
15	D12	00h: Black
16	D13	D10:LSB D17:MSB
17	D14	District and control of the control
18	D15	Driver has internal gamma conversion.
19	D16	
20	D17	
21	D20	
22	D21	Display data(B).
23	D22	00h: Black
24	D23	D20:LSB D27:MSB
25	D24	
26	D25	Driver has internal gamma conversion.
27	D26	
28	D27	
29	VSS	GND.
30	CLK	Clock signal.Latching data at the falling edge.
31	STBYB	Standby signal input. (Hi:Normal operation, Lo:Standby operation)
32	HSYNC	Horizontal sync signal input. (Low active)
33	VSYNC	Vertical sync signal input. (Low active)
34	DE	Input data effective signal. (It is effective for the period of "Hi")
35	NC	OPEN.
36	VSS	GND.
37	NC	OPEN.
38	NC	OPEN.
39	NC	OPEN.
40	NC	OPEN.
41	VSS	GND.
42	BLL	Backlight drive (cathode side)
43	BLH	Backlight drive (anode side)
44	NC	OPEN.
45	NC	OPEN.

- Recommended connector: HIROSE ELECTRIC FH12 series [FH12A-45S-0.5SH(55)]
- Please make sure to check a consistency between pin assignment in "3.2 Outward Form" and your connector pin assignment when designing your circuit.

 Inconsistency in input signal assignment may cause a malfunction.
- Since FPC cable has gold plated terminals, gilt finish contact shoe connector is recommended.

5. Absolute Maximum Rating

VSS=0V

Item	Symbol	Condition	Rating		Unit	Applicable terminal
			MIN	MAX		
Supply voltage	VDD	Ta=25° C	-0.3	5.0	V	VDD
Input voltage for logic	VI		-0.3	VDD+0.3	V	CLK,VSYNC,HSYNC,DE D[27:20],D[17:10],D[07:00], STBYB
LED direction current	IL	Ta=25° C		35	mA	BLH - BLL
of order		Ta=70° C		15		
Storage temperature range	Tstg		-30	80	°C	
Storage humidity range	Hstg	Non condensing in an environmental moisture at or less than 40 °C90%RH.				

6. Recommended Operating Conditions

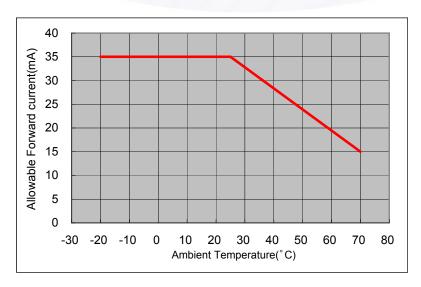
VSS=0V

Item	Symbol	Condition	Rating		Unit	Applicable terminal	
			MIN	TYP	MAX		
Supply voltage	VDD		3.0	3.3	3.6	V	VDD
Input voltage for logic	VI	VDD=3.0~	0		VDD	V	CLK,VSYNC,HSYNC,
		3.6V					DE,D[27:20],D[17:10],
							D[07:00],STBYB
Operating temperatur	Тор	Note 1,2	-20	25	70	°C	Panel surface
range							temperature
Operating humidity		Ta≦30° C	20		80	%	
range	Hop	Ta>30° C	Non condensing in				
			an envi <mark>ronm</mark> ental m <mark>oistur</mark> e at or				
			less than 30	0°C80%RH			

Note1: This monitor is operatable in this temperature range. With regard to optical characteristics, refer to Item "10. CHARACTERISTICS".

Note2: Acceptable Forward Current to LED is up to 15mA, when Ta=+70 °C.

Do not exceed Allowable Forward Current shown on the chart below.



7. Characteristics

7.1 DC Characteristics

7.1.1 Display Module

(Unless otherwise noted, Ta=25°C,VDD=3.3V,VSS=0V)

Item	Symbol	Condition		Rating		Unit	Applicable terminal
			MIN	TYP	MAX		
Input voltage	VIH	VDD=3.0~3.6V	0.7×VDD		VDD	V	CLK,VSYNC,HSYNC,
for logic							DE,D[27:20],D[17:10],
	VIL		0	-	0.3×VDD	V	D[07:00],STBYB
Pull down	Rpd			200		kΩ	DE,D[27:20],D[17:10],
resister value							D[07:00]
Pull up	Rpu			200		kΩ	VSYNC,HSYNC,
resister value							STBYB
Current	IDD	fCLK=9MHz		17	34	mΑ	VDD
consumption		Color bar display					
Standby Current	IDDs	Other input with constant		100	200	μΑ	
		voltage					

7.1.2 Backlight

Item	Symbol	Condition		Rating		Unit	Applicable terminal
			MIN	TYP	MAX		
Forward current	IL25	Ta=25° C		10.0	35.0	mA	BLH - BLL
	IL70	Ta=70° C		-	15.0	mA	
Forward voltage	VL	Ta=25° C, IL=10.0mA		27.0	29.7	V	
Estimated Life	LL	Ta=25° C, IL=10.0mA		(20,000)		hr	
of <mark>LE</mark> D		Note					

Note: - The lifetime of the LED is defined as a period till the brightness of the LED decreases to the half of its initial value.

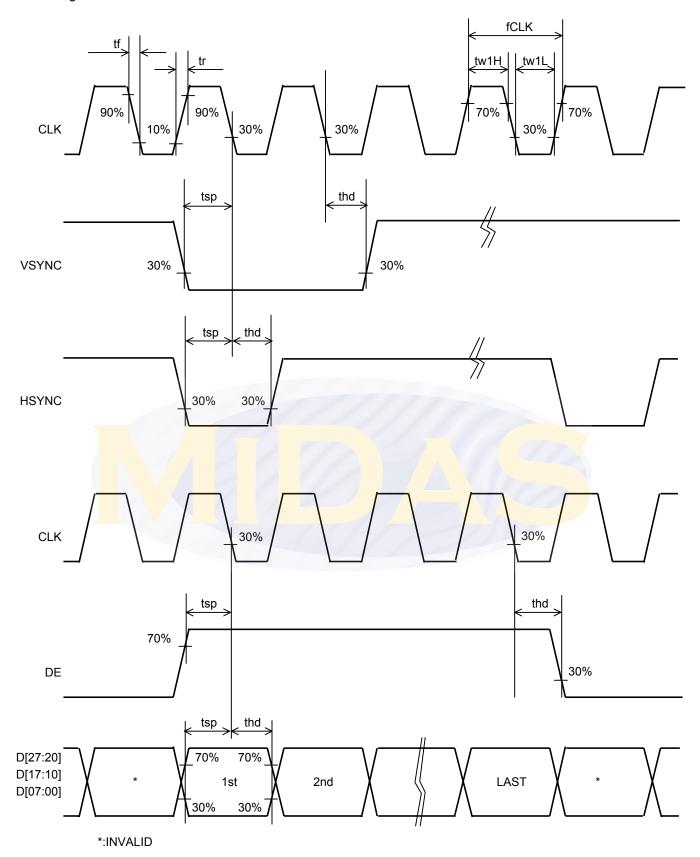
- This figure is given as a reference purpose only, and not as a guarantee.
- This figure is estimated for an LED operating alone.
 As the performance of an LED may differ when assembled as a monitor together with a TFT panel due to different environmental temperature.
- Estimated lifetime could vary on a different temperature and usually higher temperature could reduce the life significantly.

7.2 AC Characteristics

(Unless otherwise noted, Ta=25°C,VDD=3.3V,VSS=0V)

			(Offices office	i wise noted	, ra-25	C,VDD=3.3V,V33=0V)
Item	Symbol	Condition		Rating		Unit	Applicable terminal
			MIN	TYP	MAX		
CLK frequency	fCLK		5.0	9.0	12.0	MHz	CLK
CLK rising time	tr	10%→90%		1	9	ns	
CLK falling time	tf	90%→10%		1	9	ns	
CLK Low period	tw1L	0.3×VDD or less.	0.4/fCLK		0.6/fCLK	ns	
CLK High period	tw1H	0.7×VDD or more.	0.4/fCLK		0.6/fCLK	ns	
Setup time	tsp		12.0			ns	CLK,VSYNC,HSYNC,
Hold time	thd		12.0			ns	DE,D[27:20],D[17:10],
							D[07:00]

Switching Waveform Characteristics



7.3 Input Timing Characteristics

(Unless otherwise noted, Ta=25°C,VDD=3.3V,VSS=0V)

Item	Symbol	Rating			Unit	Applicable terminal
		MIN	TYP	MAX		
VSYNC frequency Note	fVSYNC	54	60	66	Hz	VSYNC
VSYNC signal cycle time	tv	277	288	400	Н	VSYNC,HSYNC
VSYNC pulse width	tw2H	1			Н	
Vertical back porch	tvb	3	8	31	Н	
Vertical front porch	tvf	2	8	93	Н	
Vertical display period	tvdp		272		Н	VSYNC,HSYNC,DE,D[27:20], D[17:10],D[07:00]
HSYNC frequency	fHSYNC	15.38	16.67	18.18	Khz	HSYNC
HSYNC signal cycle time	th	520	525	800	CLK	HSYNC,CLK
HSYNC pulse width	tw3H	1			CLK	
Horizontal back porch	thb	36	40	255	CLK	HSYNC,DE,CLK
Horizontal front porch	thf	4	5	65	CLK	
Horizontal display period	thdp		480		CLK	DE,D[27:20],D[17:10],D[07:00], CLK
DE pulse width	tw4H		480	/ - /	CLK	DE,CLK

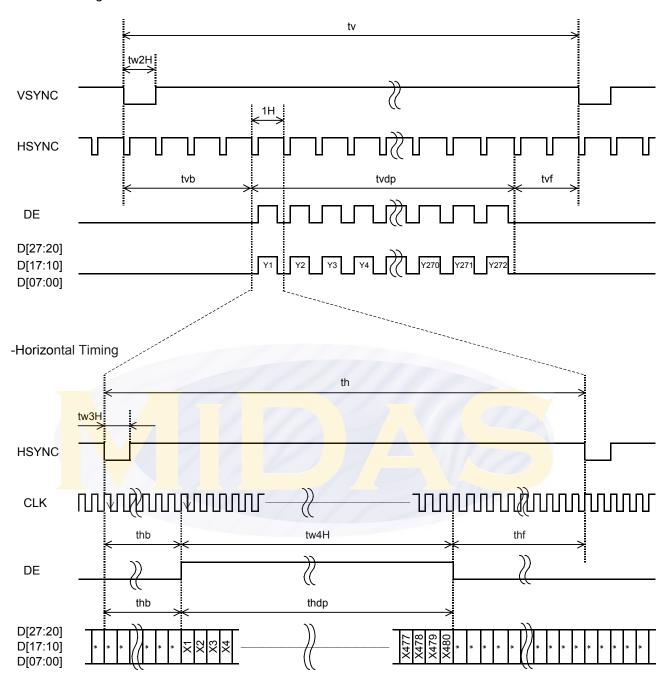
Note: The characteristic of this item is recommended standard.

Please use it after it confirms it enough like the display fineness etc.

When it comes off from this characteristic and it is used.

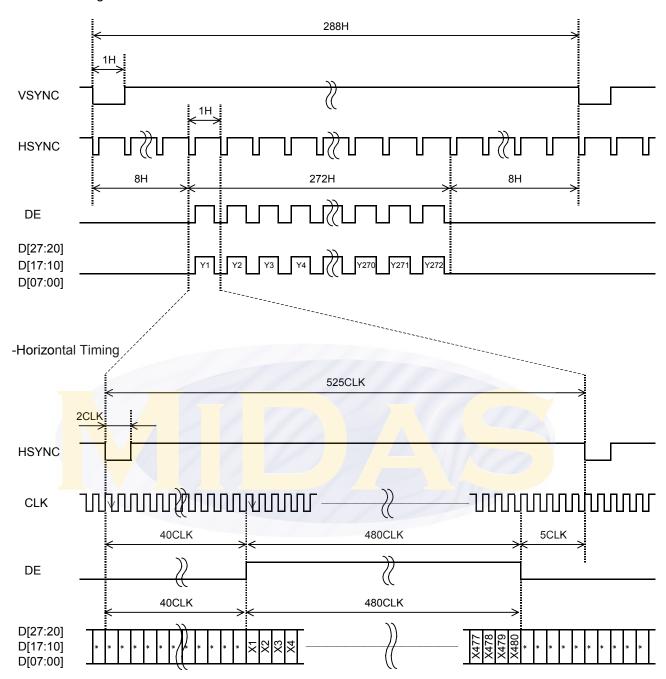
7.4 Driving Timing Chart

-Vertical Timing



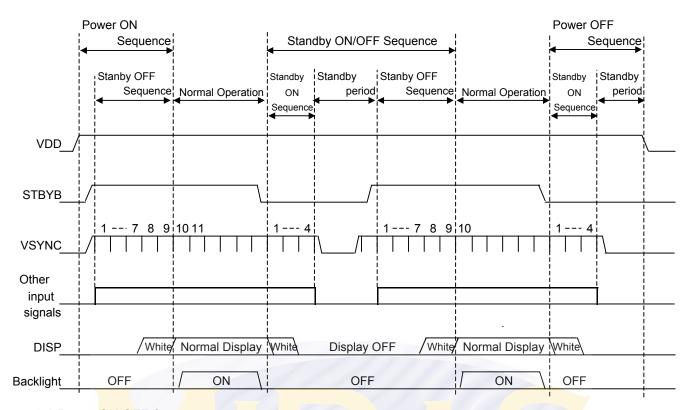
7.5 Example of Driving Timing Chart (fCLK=9.0MHz)

-Vertical Timing



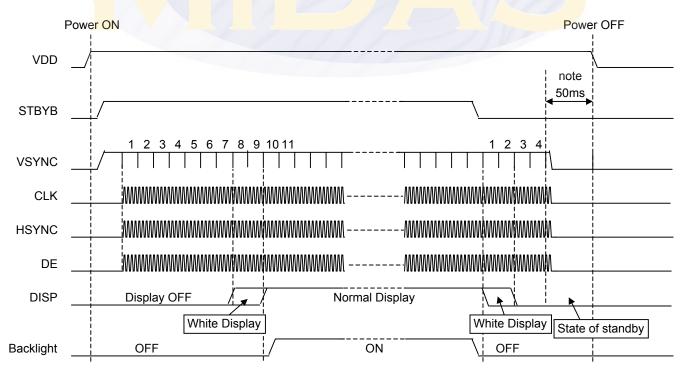
8. Description of Sequence

The outline of "Power ON/OFF Sequence" and "Standby ON/OFF Sequence" is shown below.



8.1 Power ON/OFF Sequence

The sequence of the Power On/Off and the signal input must defend the following conditions.



Note: For Power OFF,please turn off VDD since 50msec after the standby state shifts.

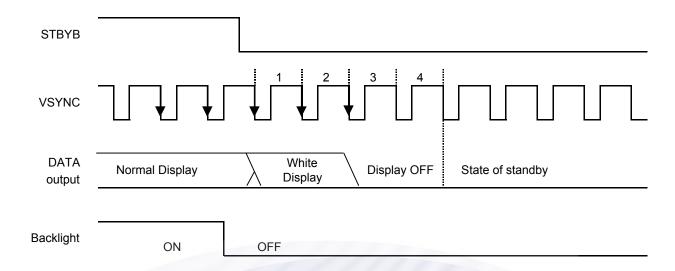
When CLK and the VSYNC signal are stopped or the power supply is turned off to a regulated frame or less, the afterimage might remain.

8.2 Stanby ON/OFF Sequence

It explains Standby ON/OFF sequence by the STBYB signal.

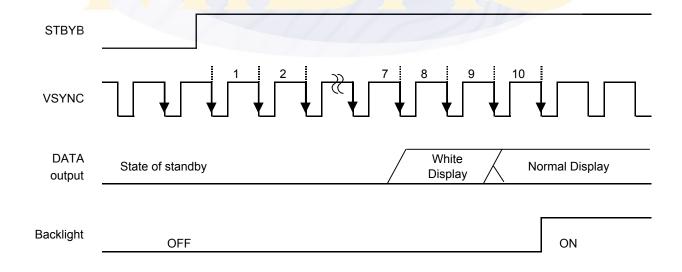
The following time will be needed by the shift in the state of the standby from the standby setting according to the STBYB signal.

Meanwhile, VSYNC signal and the CLK signal should keep being supplied.

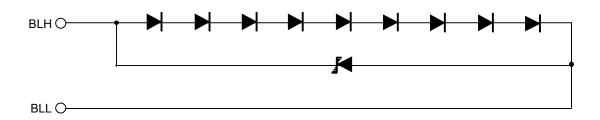


Similarly, the time of nine frames will be needed by the time a usual display is begun from the standby release by the STBYB signal.

Please begin outputting in the 8th frame on the Display Data.



9. LED Circuit





10. Characteristics

10.1 Optical Characteristics

< Measurement Condition >

Measuring instruments: CS1000 (KONICA MINOLTA), LCD7000(OTSUKA ELECTRONICS),

EZcontrast160D (ELDIM)

Driving condition: VDD = 3.3V,VSS=0V

Optimized VCOMDC

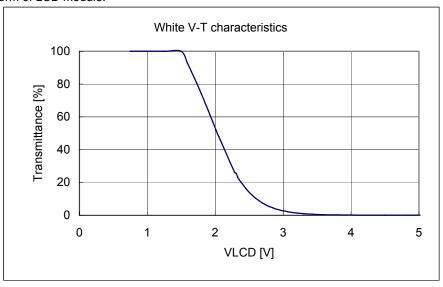
VLCD= | Vsigpp±Vcompp | /2

Backlight: IL=10mA Measured temperature: Ta=25° C

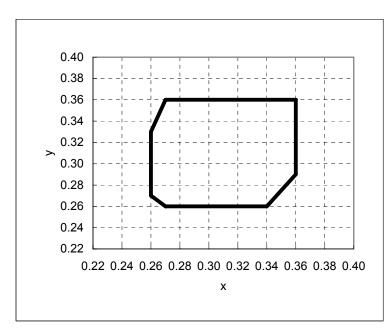
Measured temperature: Ta=25 C									
	Item	Symbol	Condition	MIN	TYP	MAX	Unit	Note No.	Remark
Response time	Rise time	TON	VLCD= 0.5V→4.8V	_		40	ms	1	*
Resp tin	Fall time	TOFF	VLCD= 4.8V→0.5V	_		60	ms		
Contrast ratio	Backlight ON	CR	VLCD= 0.5V/4.8V	240	400	1		2	
Con	Backlight OFF			_	7.5	1			
J	Left	θL	VLCD=	80	_		deg	3	*
Viewing angle	Right	θR	0.5V/4.8V	80	_	_	deg		
/iev	Up	φU	CR≧10	80	_	_	deg		
	Down	φD		80	_	_	deg		
\	ara ah ald	V90		1.2	1.5	1.8	V	4	*
v-i u	nreshold	V50		1.7	2.0	2.3	V		
voltaç	je	V10		2.2	2.5	2.8	V		
Whi	te V-T Cu <mark>rve</mark>			White V-	T Curve		/ A		Reference
\\/bitc	Chromoticity	Х	VLCD=0.5V	White ch	ıromatici <mark>t</mark>	<mark>y ra</mark> nge		5	
White Chromaticity			1 0						
	Burn-in			No noticeable burn-in image should be observed after 2 hours of window pattern display.			2 hours	6	
Cente	er brightness		VLCD=0.5V	315	450	_	cd/m ²	7	
Brigh	tness distributio	on	VLCD=0.5V	70	_	_	%	8	

^{*} Note number 1 to 8: Refer to the APPENDIX of "Reference Method for Measuring Optical Characteristics".

Measured in the form of LCD module.



White V-T Curve



[White Chromaticity Range]

Х	У
0.26	0.33
0.26	0.27
0.27	0.26
0.34	0.26
0.36	0.29
0.36	0.36
0.27	0.36

White Chromaticity Range

10.2 Temperature Characteristics

< Measurement Condition >

Measuring instruments: CS1000 (KONICA MINOLTA), LCD7000(OTSUKA ELECTRONICS)

Driving condition: VDD = 3.3V,VSS=0V

Optimized VCOMDC

VLCD= | Vsigpp±Vcompp | /2

Backlight: IL=10mA

Item			Specif	fication	Remark
			Ta=-10° C	Ta=70° C	Keillaik
Contrast ratio		CR	40 or more	40 or more	Backlight ON
Response time	Rise time	TON	200 msec or less	30 msec or less	*
rresponse time	Fall time	TOFF	300 msec or less	50 msec or less	*
Display Quality			No noticeable display defect or ununiformity should be observed.		Use the criteria for judgment specified in the section 11.

^{*} Measured in the form of LCD module.

11. Criteria of Judgment

11.1 Defective Display and Screen Quality

Test Condition: Observed TFT-LCD monitor from front during operation with the following conditions

Driving Signal Raster Patter (RGB in monochrome, white, black)

Signal condition VLCD:0.5V, 2.2V, 4.8V (3 steps)

Observation distance 30 cm
Illuminance 200 to 350 lx
Backlight IL=10mA

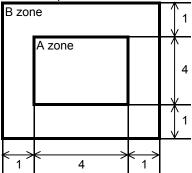
De	Defect item Defect content		Defect content	Criteria					
	Line defect	Black, white or cold	or line, 3 or more neighboring defective dots	Not exists					
Ϊξ		Uneven brightness	on dot-by-dot base due to defective						
Quality		TFT or CF, or dust	is counted as dot defect						
	Dot defect	(brighter dot, darke	r dot)	Refer to table 1					
Display	Dot delect	High bright dot: Vis	ible through 2% ND filter at VLCD=4.8V	Refer to table 1					
Dis		Low bright dot: Vis	ible through 5% ND filter at VLCD=4.8V						
		Dark dot: Appear d	ark through white display at VLCD=2.2V						
	Dirt	Point-like uneven b	rightness (white stain, black stain etc)	Invisible through 1% ND filter					
>		Point-like	0.25mm<φ	N=0					
Quality		F	F	Faraire	Eoroign	Foreign		0.20<φ≦0.25mm	N≦2
g			φ≦0.20mm	Ignored					
en		Liner	3.0mm <length 0.08mm<width<="" and="" td=""><td>N=0</td></length>	N=0					
Screen		length≤3.0mm or width≤0.08mm		Ignored					
0	Others			Use boundary sample					
	Others			for judgment when necessary					

φ(mm): Average diameter = (major axis + minor axis)/2
Permissible number: N

Table 1

Table					
Area	H <mark>igh</mark> bright dot	Low bright dot	Dark dot	Total	Criteria
А	0	2	2	3	Permissible distance between same color bright dots (includes neighboring dots): 3 mm or more
В	2	4	4	6	Permissible distance between same color high bright dots (includes neighboring dots): 5 mm or more
Total	2	4	4	7	

<Landscape model>



Division of A and B areas

B area: Active area

Dimensional ratio between A and B areas: 1: 4: 1 (Refer to the left figure)

(23/33)

SPECIFICATIONS No. 09TLM022

Issue: Apr. 1, 2010

11.2 Screen and Other Appearance Testing conditions

Observation distance 30cm

Illuminance 1200~2000 lx

	Item	Criteria	Remark
	-		
	Flaw	Ignore invisible defect when the backlight is on.	Applicable area:
zer	Stain		Active area only
Polarizer	Bubble		(Refer to the section
Pol	Dust		3.2 "Outward form")
	Dent		
	S-case	No functional defect occurs	
	FPC cable	No functional defect occurs	



12. Reliability Test

High temperature storage Ta=80° C 240H 0/3	Test item		Test condition	number of failures
Low temperature storage High temperature & high humidity storage humidity storage Tp=70°C Tp=70°C Tp=20°C Tp=20°C Tp=40°C Thigh temperature operation Tp=20°C Tp=40°C Tp=20°C Tp=40°C		Lligh to your party we at a your	To-00° C 240H	/number of examinations
High temperature & high humidity storage High temperature operation To 240H To 240H To 240H To 240H To 240H To 240H To 20°C To 240H To 24		•		
Humidity storage Non condensing High temperature operation Tp=70°C 240H 0/3		·		
High temp & humid operation non condensing	iest			0/3
High temp & humid operation non condensing	Ιξ		-	0.70
High temp & humid operation non condensing	abil		•	
High temp & humid operation non condensing)ura	Low temperature operation	l '	
Thermal shock storage 30 → 80° C(30min/30min) 100 cycles Confirms to EIAJ ED-4701/300 Color Ed-40 ED-4		High temp & humid operation	1 •	0/3
Electrostatic discharge test (Non operation) Electrostatic discharge test (Non operation) Electrostatic discharge test (Non operation) Euch 3 times of discharge on and power supply and other terminals. Surface discharge test (Non operation) Each 5 times of discharge in both polarities on the center of screen with the case grounded. FPC tension test FPC tension test FPC bend test FPC bend test FPC bend test Vibration test FPC bend test Total amplitude 1.5mm, f=10~55Hz, X,Y,Z directions for each 2 hours O/3 Impact test FPC bend test FPC with the force of 3N for 10 sec. In the direction -180-degree to its original direction. Reciprocate it 3 times. FPC bend test FPC with the force of 3N for 10 sec. In the direction -180-degree to its original direction. FPC with the force of 3N for 10 sec. In the direction -180-degree to its original direction. FPC bend test FPC with the force of 3N for 10 sec. In the direction -180-degree to its original direction. FPC with the force of 3N for 10 sec. In the direction -180-degree to its original direction. FPC bend test FPC with the force of 3N for 10 sec. In the direction -90-degree to its original direction. FPC bend test FPC bend test				
Electrostatic discharge test (Non operation) Electrostatic discharge test (Non operation) Electrostatic discharge test (Non operation) Surface discharge test (Non operation) Each 3 times of discharge on and power supply and other terminals. C=250pF, R=100Ω, V=±12kV Each 5 times of discharge in both polarities on the center of screen with the case grounded. Pull the FPC with the force of 3N for 10 sec. in the direction - 90-degree to its original direction. Pull the FPC with the force of 3N for 10 sec. in the direction -180-degree to its original direction. Reciprocate it 3 times. Vibration test Vibration test Total amplitude 1.5mm, f=10 ∼55Hz, X,Y,Z directions for each 2 hours original jig (see next page) and make an impact with peak acceleration of 1000m/s² for 6 msec with half sine-curve at 3 times to each X, Y, Z directions in conformance with JIS 60068-2-27-1995. Packing vibration-proof test Packing dron test Each 5 times of discharge on and power supply and other terminals. C=250pF, R=100Ω, V=±12kV 0 √3 FPC bend test Total amplitude 1.5mm, f=10 ∼55Hz, X,Y,Z 0 √3 directions for each 2 hours original jig (see next page) and make an impact with peak acceleration of 1000m/s² for 6 msec with half sine-curve at 3 times to each X, Y, Z directions in conformance with JIS 60068-2-27-1995. Acceleration of 19.6m/s² with frequency of 10 →55 →10Hz, X,Y, Z direction for each 30 minutes Packing dron test Drop from 75cm high. Drop from 75cm high.		Thermal shock storage		
Surface discharge test (Non operation) Each 3 times of discharge on and power supply and other terminals.				0/3
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1 time to each 6 surfaces, 3 edges, 1 corner	aç X	Dooking draw toot	Drop from 75cm high.	0/1 Packing
	ی	Packing drop test	· ·	

Note:Ta=ambient temperature

Tp=Panel temperature

% The profile of high temperature/humidity storage and High Temperature/humidity operation (Pure water of over 10M Ω ·cm shall be used.)

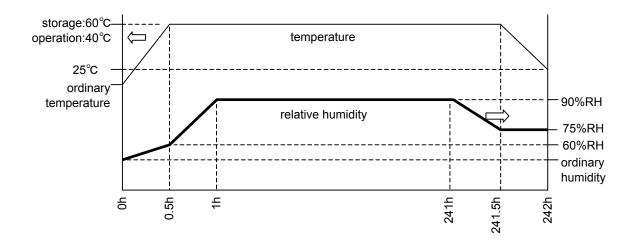
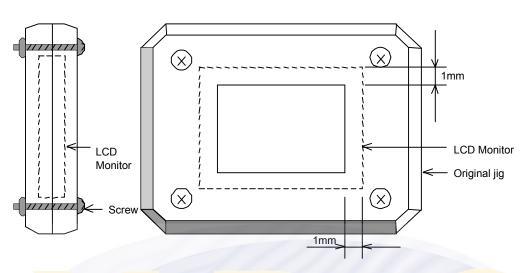


Table2.Reliability Criteria

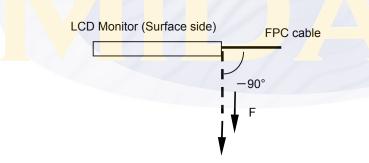
Measure the parameters after leaving the monitor at the ordinary temperature for 2 hours or more after the test completion.

item	Standard	Remarks
Display quality	No visible abnormality shall be seen.	As criteria of
		"11 Criteria of Judgment".
Contrast ratio	40 or more	Backlight ON

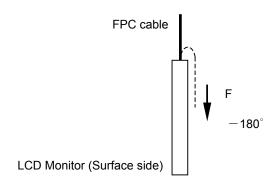
Original Jig



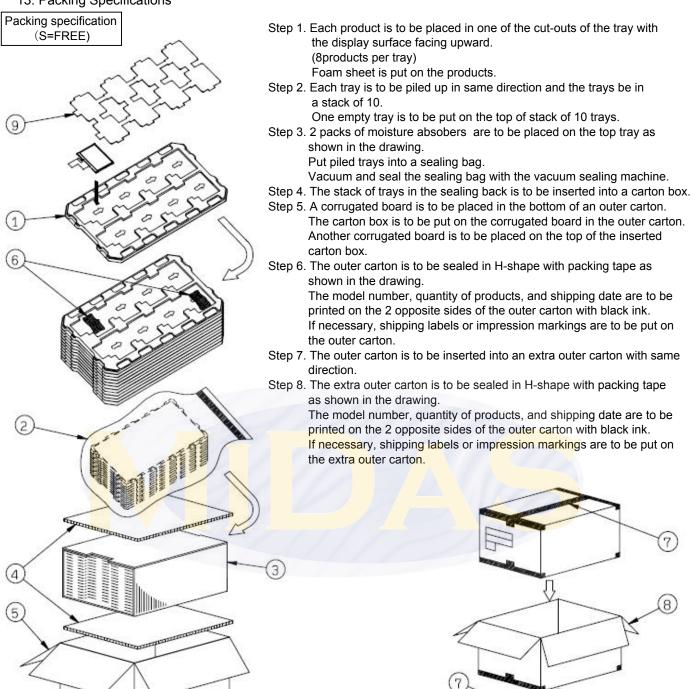
Tension Test Method for FPC cable



Bend Test Method for FPC cable

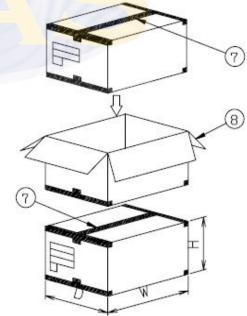


13. Packing Specifications



Remark: The return of packing materials is not required.

	Packing item name	Specs., Material
	r acking item name	Specs., Material
1	Tray	A-PET Antistatic
2	Sealing bag	
3	Carton box	Corrugated cardboard
4	Inner board	Corrugated cardboard
5	Outer carton	Corrugated cardboard
6	Drier	Moisture absorber
7	Packing tape	
8	Extra outer carton	Corrugated cardboard
9	Foam sheet	PE Anti-static



Dimension of extra outer carton			
D : Approx.	(338mm)		
W : Approx.	(549mm)		
H : Approx.	(198mm)		
Quantity of products packed in one carton:		80	
Gross weight : A	pprox. 6.7Kg		

14. Handling Instruction

14.1 Cautions for Handling LCD panels



Caution

- (1) Do not make an impact on the LCD panel glass because it may break and you may get injured from it.
- (2) If the glass breaks, do not touch it with bare hands.(Fragment of broken glass may stick you or you cut yourself on it.
- (3) If you get injured, receive adequate first aid and consult a medial doctor.
- (4) Do not let liquid crystal get into your mouth.
 (If the LCD panel glass breaks, try not let liquid crystal get into your mouth even toxic property of liquid crystal has not been confirmed.
- (5) If liquid crystal adheres, rinse it out thoroughly. (If liquid crystal adheres to your cloth or skin, wipe it off with rubbing alcohol or wash it thoroughly with soap. If liquid crystal gets into eyes, rinse it with clean water for at least 15 minutes and consult an eye doctor.
- (6) If you scrape this products, follow a disposal standard of industrial waste that is legally valid in the community, country or territory where you reside.
- (7) Do not connect or disconnect this product while its application products is powered on.
- (8) Do not attempt to disassemble or modify this product as it is precision component.
- (9) If a part of soldering part has been exposed, and avoid contact (short-circuit) with a metallic part of the case etc. about FPC of this model, please. Please insulate it with the insulating tape etc. if necessary. The defective operation is caused, and there is a possibility to generation of heat and the ignition.
- (10) Since excess current protection circuit is not built in this TFT module, there is the possibility that LCD module or peripheral circuit become feverish and burned in case abnoramal operation is generated. We recommend you to add excess current protection circuit to power supply.



Caution

This mark is used to indicate a precaution or an instruction which, if not correctly observed, may result in bodily injury, or material damages alone.

14.2 Precautions for Handling

- Wear finger tips at incoming inspection and for handling the TFT monitors to keep display quality and keep the working area clean.
 Do not touch the surface of the monitor as it is easily scratched.
- Wear grounded wrist-straps and use electrostatic neutralization blowers to prevent static charge and discharge when handling the TFT monitors as the LED in this TFT monitors is damageable to electrostatic discharge, Properly set up equipment, jigs and machines, and keep working area clean and tidy for handling the TFT monitors.
- 3) Avoid strong mechanical shock including knocking, hitting or dropping to the TFT monitors for protecting their glass parts. Do not use the TFT monitors that have been experienced dropping or strong mechanical shock.
- 4) Do not use or storage the TFT monitors at high temperature and high humidity environment. Particularly, never use or storage the TFT monitors at a location where condensation builds up.
- 5) Avoid using and storing TFT monitors at a location where they are exposed to direct sunlight or ultraviolet rays to prevent the LCD panels from deterioration by ultraviolet rays.
- 6) Do not stain or damage the contacts of the FPC cable . Otherwise, it may cause poor contact or deteriorate reliability of the FPC cable.
- 7) Do not bend or pull the FPC cable or carry the TFT monitor by holding the FPC cable.
- 8) Peel off the protective film on the TFT monitors during mounting process.

 Refer to the section 14.5 on how to peel off the protective film.

 We are not responsible for electrostatic discharge failures or other defects occur when peeling off the protective film.

14.3 Precautions for Operation

- 1) Since this TFT monitors are not equipped with light shielding for the driver IC, do not expose the driver IC to strong lights during operation as it may cause functional failures.
- 2) When turning off the power, turn off the input signal before or at the same timing of switching off the power.
- 3) Do not plug in or out the FPC cable while power supply is switch on. Plug the FPC cable in and out while power supply is switched off.
- 4) Do not operate the TFT monitors in the strong magnetic field. It may break the TFT monitors.
- 5) Do not display a fixed image on the screen for a long time. Use a screen-saver or other measures to avoid a fixed image displayed on the screen for a long time. Otherwise, it may cause burn-in image on the screen due the characteristics of liquid crystal.

14.4 Storage Condition for Shipping Cartons

Storage environment

Temperature 0 to 40° CHumidity 60%RH or less

No-condensing occurs under low temperature with high humidity condition.

Atmosphere No poisonous gas that can erode electronic components and/or wiring

materials should be detected.

Time period 3 months

Unpacking
 To protect the TFT monitors from static damage during unpacking, keep room

humidity more than 50%RH and implement effective countermeasures against static electricity such as establishing a ground (an earth) before unpacking.

Maximum piling up 7 cartons

14.5 Precautions for Peeling off the Protective film

The followings work environment and work method are recommended to prevent the TFT monitors from static damage or adhesion of dust when peeling off the protective films.

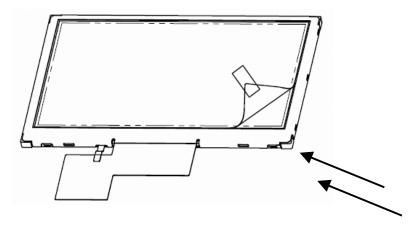
A) Work Environment

- a) Humidity: 50 to 70 %RH, Temperature15 to 27°C
- b) Operators should wear conductive shoes, conductive clothes, conductive finger tips and grounded wrist-straps. Anti-static treatment should be implemented to work area's floor.
- c) Use a room shielded against outside dust with sticky floor mat laid at the entrance to eliminate dirt.

B) Work Method

The following procedures should taken to prevent the driver ICs from charging and discharging.

- a) Use an electrostatic neutralization blower to blow air on the TFT monitors to
 its lower right when the FPC cable is facing to the downside.
 Optimize direction of the blowing air and the distance between the TFT monitors
 and the electrostatic neutralization blower.
- b) Put an adhesive tape (Scotch tape, etc) at the lower right corner area of the protective film to prevent scratch on surface of TFT monitor.
- c) Peel off the adhesive tape slowly (spending more than 2 seconds to complete) by pulling it to opposite direction.



Direction of blowing air (Optimize air direction and the distance)

APPENDIX

Reference Method for Measuring Optical Characteristics and Performance

1. Measurement Condition (Backlight ON)

Measuring instruments: CS1000 (KONICA MINOLTA), LCD7000(OTSUKA ELECTRONICS), EZcontrast160D (ELDIM)

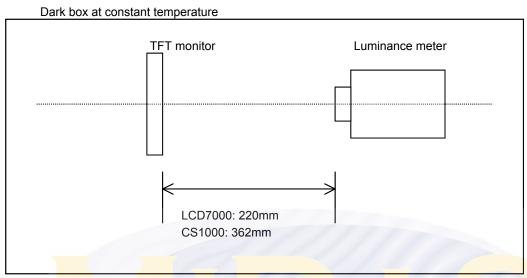
Driving condition: Refer to the section "Optical Characteristics"

Measured temperature: 25°C unless specified

Measurement system: See the chart below. The luminance meter is placed on the normal line of

measurement system.

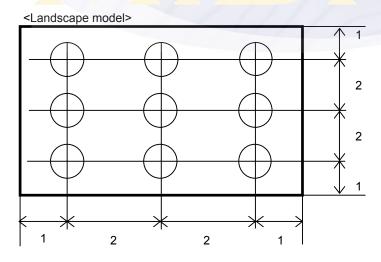
Measurement point: At the center of the screen unless otherwise specified



Measurement is made after 30 minutes of lighting of the backlight.

Measurement point: At the center point of the screen

Brightness distribution: 9 points shown in the following drawing.



Dimensional ratio of active area

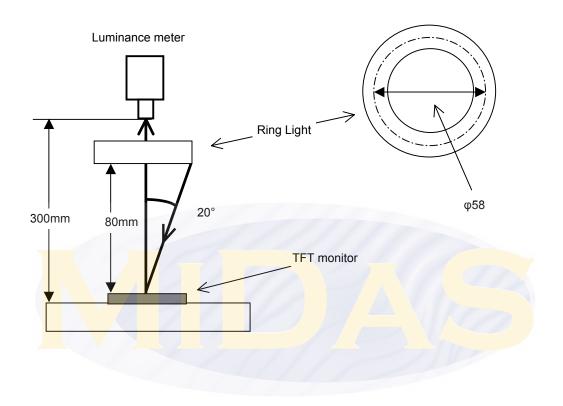
Backlight IL=10mA

Measurement Condition (Contrast ratio Backlight OFF only)

Measuring instruments: LCD7000(OTSUKA ELECTRONICS),Ring Light(40,000 lx,φ58)

Driving condition: Refer to the section "Optical Characteristics"

Measured temperature: 25°C unless specified
Measurement system: See the chart below.
Measurement point: At the center of the screen.



2. Test Method

Ī	Notice	Item	Test method	Measuring	Remark
	1101100	itom	root moulou	instrument	Romanc
ŀ	1	Response	Measure output signal waveform by the luminance	LCD7000	Black display
		time	meter when raster of window pattern is changed from		VLCD=4.8V
			white to black and from black to white.		White display
					VLCD=0.5V
					TON
			White Black White		Rise time
					TOFF
			White		Fall time
			100%		
			\		
			90%		
			10%		
			10 70		
			0%		
			Black		
ŀ	2	Contrast ratio	Measure maximum luminance Y1(VLCD=0.5V) and	CS1000	Backlight ON
	2	Contract ratio	minimum luminance Y2(VLCD=4.8V) at the center of	LCD7000	Backlight OFF
			the screen by displaying raster or window pattern.	2057000	Daoi ang Fit Of F
			Then calculate the ratio between these two values.		
			Contrast ratio = Y1/Y2		
			Diameter of measuring point: 8mmφ		
	3	Viewing	Move the luminance meter from right to left and up	EZcontrast160D	
		angle	and down and determine the angles where		
		Horizontalθ	contrast ratio is 10.		
ļ	1	Verticalφ	Change VLCD by 0.1V step and plot the points where	L CD7000	
	4	V-T threshold	the luminance is 90% as V90, 50% as V50 and 10% as	LCD7000	
		value	V10 of maximum luminance.		
			t 10 of maximum annual co.		
			100%		
			Luminance 50%		
			Tan Land		
			है 50%		
			10%		
			0 V90 V50 V10		
ļ	5	\\/hito	Measure chromaticity coordinates x and y of CIE1931	CS1000	
	Э	White chromaticity	colorimetric system at VLCD = 0.5V	001000	
		omomaticity	Color matching faction: 2°view		
			Color matering raction. 2 view		
L				<u> </u>	

Notice	Item	Test method	Measuring instrument	Remark
6	Burn-in	Visually check burn-in image on the screen after 2 hours of "window display" (VLCD=0.5V/4.8V).		At optimized VCOMDC
7	Center brightness	Measure the brightness at the center of the screen.	CS1000	
8	Brightness distribution	(Brightness distribution) = 100 x B/A % A: max. brightness of the 9 points B: min. brightness of the 9 points	CS1000	

